

#### **Features**

- · Excellent Package for Heat Dissipation
- High Density Cell Design for Low R<sub>DS(ON)</sub>
- · Epoxy Meets UL 94 V-0 Flammability Rating
- · Moisture Sensitivity Level 1
- · Halogen Free. "Green" Device (Note 1)
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

## **Maximum Ratings**

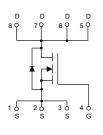
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 5°C/W Junction to Case

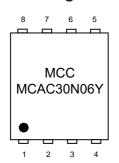
Parameter		Symbol	Rating	Unit
Drain-Source Voltage		V <sub>DS</sub>	60	V
Gate-Source Volltage		V <sub>GS</sub>	±20	V
Continuous Drain Current	T <sub>C</sub> =25°C	- I <sub>D</sub>	30	Α
	T <sub>C</sub> =100°C		19	Α
Pulsed Drain Current		I <sub>DM</sub>	130	Α
Avalanche Energy, Single Pulse <sup>(Note 2)</sup>		E <sub>AS</sub>	100	mJ
Total Power Dissipation		P <sub>D</sub>	30	W

Note: 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

2.  $T_j=25$ °C,  $V_{DD}=40V$ ,  $V_{G}=10V$ , L=0.5mH,  $R_{Q}=25\Omega$ 

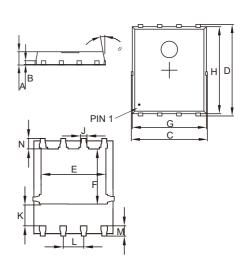
## **Internal Structure and Marking Code**





# N-CHANNEL MOSFET

## **DFN5060**



	DIMENSIONS					
DIM	INCHES		MM		NOTE	
	MIN	MAX	MIN	MAX	NOTE	
Α	0.031	0.047	0.80	1.20		
В	0.010		0.254		TYP.	
С	0.193	0.222	4.90	5.64		
D	0.232	0.250	5.90	6.35		
Е	0.148	0.167	3.75	4.25		
F	0.126	0.154	3.20	3.92		
G	0.189	0.213	4.80	5.40		
Н	0.222	0.239	5.65	6.06		
K	0.045	0.059	1.15	1.50		
J	0.012	0.020	0.30	0.50		
L	0.046	0.054	1.17	1.37		
М	0.012	0.028	0.30	0.71		
N	0.016	0.028	0.40	0.71		



## Electrical Characteristics @ 25° C (Unless OtherwiseSpecified)

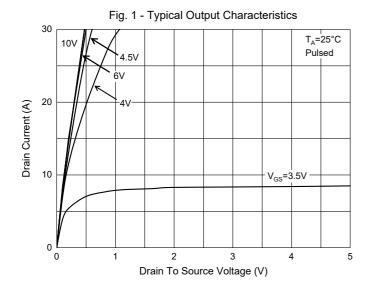
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit	
Static Parameter					-		
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	60			V	
Gate-Threshold Voltage <sup>(Note 3)</sup>	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_D=250\mu A$	1.0	1.5	2.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	μA	
Drain-Source On-Resistance <sup>(Note 3)</sup>		V <sub>GS</sub> =10V, I <sub>D</sub> =15A		16	20	— mΩ	
	$R_{DS(on)}$	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A		17.5	22		
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V, I <sub>S</sub> =10A		0.85	1.2	V	
Dynamic Parameters <sup>(Note 4)</sup>					!		
Input Capacitance	C <sub>iss</sub>			1552			
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ =30V, $V_{GS}$ =0V, f=1MHz		192		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			133			
Switching Parameters <sup>(Note 4)</sup>			,				
Total Gate Charge	$Q_g$			48			
Gate-Source Charge	$Q_{gs}$	V <sub>GS</sub> =10V,V <sub>DS</sub> =30V, I <sub>D</sub> =15A		7		0	
Gate-Drain Charge	$Q_{gd}$			10		nC	
Reverse Recovery Charge	Q <sub>rr</sub>	1 - 40A - 4:/-4t500A/		47			
Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =10A, di/dt=500A/us		39			
Turn-On Delay Time	t <sub>d(on)</sub>			11			
Turn-On Rise Time	tr	V <sub>DD</sub> =30V,V <sub>GS</sub> =10V,		6		ns	
Turn-Off Delay Time	$t_{d(off)}$	$R_L$ =1 $\Omega$ , $I_D$ =2A, $R_{GEN}$ =3 $\Omega$		30			
Turn-Off Fall Time	t <sub>f</sub>			9			

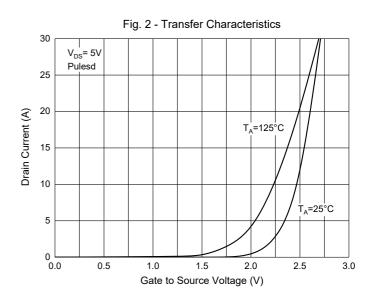
Note: 3. Pulse Test: Pulse Width  ${\leqslant}300\mu\text{s,Dduty Cycle}{\leqslant}2\%.$ 

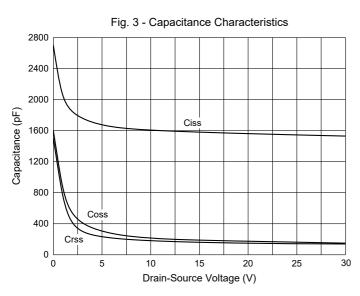
<sup>4.</sup> These Parameters Have No Way to Verify.

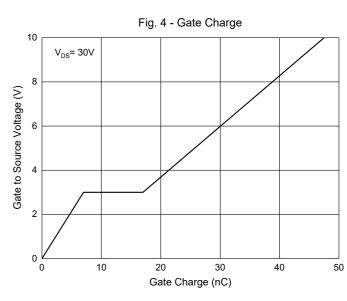


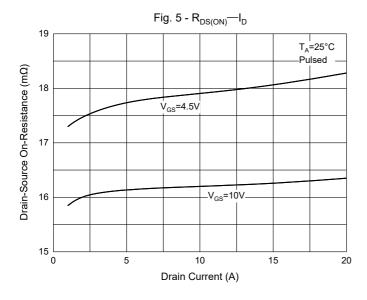
### **Curve Characteristics**

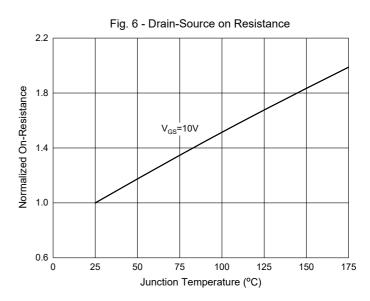






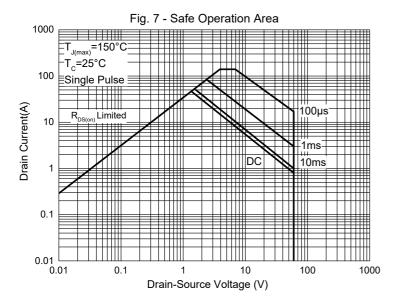








### **Curve Characteristics**





### **Ordering Information**

Device	Packing
Part Number-TP	Tape&Reel: 5Kpcs/Reel

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